

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS: 0202**

**P6T WS PRO DDR3 1067 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM socket support (Options)			
									A*	B*	C*	D*
CORSAIR	CM3X1024-1066C7	DDR3 1067	1024MB	DS	N/A	Heat-Sink Package	7	1.1	•	•	•	•
Crucial	CT12864BA1067.8SFB	DDR3 1067	1024MB	SS	MICRON	Z9HWQ	7		•	•	•	•
Crucial	CT12864BA1067.8SFD	DDR3 1067	1024MB	SS	MICRON	D9JNL	7		•	•	•	•
Crucial	CT25664BA1067.16SFD	DDR3 1067	2048MB	DS	MICRON	D9JNL	7		•	•	•	•
ELPIDA	EBJ11R08BAFA-AE-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E(ECC)	7		•	•	•	•
ELPIDA	EBJ11UD8BAFA-AG-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E	8		•	•	•	•
Hynix	HMT112U6AFP8C-G7N0	DDR3 1067	1024MB	SS	HYNIX	H5TQ1G83AFP7G7C	7		•	•	•	•
Hynix	HYMT112U64ZNF8-G7	DDR3 1067	1024MB	SS	HYNIX	HY5TQ1G831ZNFP-G7	7		•	•	•	•
Hynix	HMT125U6AFP8C-G7N0	DDR3 1067	2048MB	DS	HYNIX	H5TQ1G83AFP7G7C	7		•	•	•	•
Hynix	HYMT125U64ZNF8-G7	DDR3 1067	2048MB	DS	HYNIX	HY5TQ1G831ZNFP-G7	7		•	•	•	•
KINGSTON	KVR1066D3N7/1G	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E		1.5	•	•	•	•
KINGSTON	KVR1066D3N7/2G	DDR3 1067	2048MB	DS	SAMSUNG	K4B1G0846C-ZCF8		1.5	•	•	•	•
MICRON	MT8JTF12864AY-1G1D1	DDR3 1067	1024MB	SS	MICRON	7VD22	7		•	•	•	•
MICRON	MT16JTF25664AY-1G1D1	DDR3 1067	2048MB	DS	MICRON	7VD22	7		•	•	•	•
Qimonda	IMSH1GU03A1F1C-10F	DDR3 1067	1024MB	SS	Qimonda	IDSH1G-03A1F1C-10F	7		•	•	•	•
Qimonda	IMSH1GU03A1F1C-10G	DDR3 1067	1024MB	SS	Qimonda	IDSH1G-03A1F1C-10G	8		•	•	•	•
Qimonda	IMSH2GU13A1F1C-10F	DDR3 1067	2048MB	DS	Qimonda	IDSH1G-03A1F1C-10F	7		•	•	•	•
Qimonda	IMSH2GU13A1F1C-10G	DDR3 1067	2048MB	DS	Qimonda	IDSH1G-03A1F1C-10G	8		•	•	•	•
WINTEC	3DU3191A-10	DDR3 1067	1024MB	DS	Qimonda	IDSH51-03A1F1C-10F	7		•	•	•	•

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS: 0202**

**P6T WS PRO DDR3 1333 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM socket support (Options)
									A* B* C* D*
CORSAIR	CM3X1024-1333C9DHX	DDR3 1333	1024MB	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.1	• • • •
CORSAIR	BoxP/N:TWIN3X2048-1333C9 (CM3X1024-1333C9)Ver1.1	DDR3 1333	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.70	• • • •
CORSAIR	BoxP/N:TW3X4G1333C9DHX (CM3X2048-1333C9DHX)Ver3.2	DDR3 1333	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.70	• • • •
Crucial	CT12864BA1339.8SFB	DDR3 1333	1024MB	SS	MICRON	D9GTS	(1333-9-9-9-24)		• • • •
Crucial	CT25664BA1339.16SFD	DDR3 1333	2048MB	DS	MICRON	D9JNM	(1333-9-9-9-24)		• • • •
ELPIDA	EBJ11UD8BAFA-DG-E	DDR3 1333	1024MB	DS	ELPIDA	J5308BASE-DG-E	(1333-8-8-8-24)		• • • •
G.SKILL	F3-10600CL7D-2GBPI	DDR3 1333	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1337-7-7-7-18)	1.65	• • • •
G.SKILL	F3-10600CL8D-2GBHK	DDR3 1333	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1337-8-8-8-22)	1.65	• • • •
G.SKILL	F3-10600CL9D-2GBNQ	DDR3 1333	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.5-1.65	• • • •
KINGMAX	FLFD45F-B8EE9	DDR3 1333	1024MB	SS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)		• • • •
KINGSTON	KVR1333D3N9/1G	DDR3 1333	1024MB	SS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)	1.5	• • • •
KINGSTON	KVR1333D3N9/2G	DDR3 1333	2048MB	DS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)	1.5	• • • •
MICRON	MT8JTF12864AY-1G4BYES	DDR3 1333	1024MB	SS	MICRON	Z9HWR	(1333-9-9-9-24)		• • • •
MICRON	MT16JTF25664AY-1G4BYES	DDR3 1333	2048MB	DS	MICRON	Z9HWR	(1333-9-9-9-24)		• • • •
OCZ	OCZ3RPX1333EB2GK	DDR3 1333	1024MB	SS	N/A	Heat-Sink Package	(1066-6-5-5-20)		• • • •
OCZ	OCZ3P13332GK	DDR3 1333	1024MB	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)		• • • •
OCZ	OCZ3P13334GK	DDR3 1333	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7(1333-7-7-7-20)	1.8	• • • •
OCZ	OCZ3RPX1333EB4GK	DDR3 1333	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1066-6-5-5)	1.85	• • • •
Qimonda	IMSH2GU13A1F1C-13H	DDR3 1333	2048MB	DS	Qimonda	IDSH1G-03A1F1C-13H	9(1333-9-9-9-24)		• • • •
SAMSUNG	M378B2873DZ1-CH9	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		• • • •
SAMSUNG	M391B2873DZ1-CH9	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		• • • •
SAMSUNG	M378B5673DZ1-CH9	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		• • • •
SAMSUNG	M391B5673DZ1-CH9	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		• • • •
Transcend	TS128MLK64V3U	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		• • • •
Transcend	TS256MLK64V3U	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		• • • •
Aeneon	AEH760UD00-13H	DDR3 1333	1024MB	DS	AENEON	AEH93R13H	(1333-9-9-9-24)		• • • •
BUFFALO	FSX1333D3G-1G	DDR3 1333	1024MB	SS	N/A	Heat-Sink Package	(1066-7-7-7-20)		• • • •
BUFFALO	FSX1333D3G-2G	DDR3 1333	2048MB	DS	N/A	Heat-Sink Package	(1066-7-7-7-20)		• • • •
Elixir	M2F2G64CB8HAN-CG	DDR3 1333	2048MB	DS	Elixir	N2CB1G80AN-CG	(1333-9-9-9-24)		• • • •
Patriot	PDC32G1333LLK	DDR3 1333	1024MB	SS	PATRIOT	Heat-Sink Package	7(1337-7-7-7-20)	1.7	• • • •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS: 0202**

**P6T WS PRO DDR3 1600 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM socket support (Optional)				
									A*	B*	C*	D*	
CORSAIR	BoxP/N:TWIN3X4096-1600C7DHXIN (CM3X2048-1600C7DHXIN) Ver3.1	DDR3 1600	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1601-7-7-7-20)	1.90	•	•	•	•	
Crucial	BL12864BA1608.8SFB(XMP)	DDR3 1600	1024MB	SS	N/A	Heat-Sink Package	(1601-8-8-8-24)	1.8	•	•	•	•	
G.SKILL	F3-12800CL7D-2GBHZ	DDR3 1600	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1601-7-7-7-18)	1.9	•	•	•	•	
G.SKILL	F3-12800CL7D-4GBPI	DDR3 1600	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-18(1333-9-9-9-24)	1.9	•	•	•	•	
KINGSTON	KHX12800D3K2/4G	DDR3 1600	4096MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1066-7-7-7-20)	1.9	•	•	•	•	
OCZ	OCZ3P1600EB1G	DDR3 1600	1024MB	SS	N/A	Heat-Sink Package	7-6-6-24(1333-7-7-7-20)		•	•	•	•	
OCZ	OCZ3T1600XM2GK(XMP)	DDR3 1600	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1601-8-8-8-28)		•	•	•	•	
OCZ	OCZ3P1600EB4GK	DDR3 1600	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-6(1333-7-7-7-20)	1.8	•	•	•	•	
Aeneon	AXH760UD10-16H	DDR3 1600	1024MB	SS	N/A	Heat-Sink Package	(1601-9-9-9-28)		•	•	•	•	
Aeneon	AXH860UD20-16H	DDR3 1600	2048MB	DS	N/A	Heat-Sink Package	(1601-9-9-9-28)		•	•	•	•	
Team	BoxP/N:TXD32048M1600HC7DC (TXD31024M1600HC7)	DDR3 1600	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	7-7-7-21(1333-8-8-824)	1.75-1.85	•	•	•	•	

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409**

**P6T WS PRO DDR3 1067 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM socket support (Optional)			
									A*	B*	C*	D*
Crucial	CT12864BA1067.8SFB	DDR3 1067	1024MB	SS	MICRON	Z9HWQ	7					

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409**

**P6T WS PRO DDR3 1333 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM socket support (Optional)			
									A*	B*	C*	D*
A-DATA	AD31333E002G0U	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.65-1.85				
CORSAIR	TR3X3G1333C9 (Ver.2.1)	DDR3 1333	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5				
CORSAIR	TR3X6G1333C9 (Ver.2.1)	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5				
OCZ	OC23X13333GK	DDR3 1333	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	7-7-7(1066-6-6-6-16)	1.6				
OCZ	OC23G1333LV6GK	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65				
OCZ	OC23P1333LV6GK	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7(1066-7-7-7-20)	1.65				
Patriot	PVT33G1333ELK	DDR3 1333	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65				
Patriot	PVT36G1333ELK	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65				

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409**

**P6T WS PRO DDR3 1600 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM socket support (Options)			
									A*	B*	C*	D*
A-DATA	AD31600E001GMU(XMP)	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)	1.65-1.85	●	●	●	●
A-DATA	AD31600F002GMU(XMP)	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.75-1.85	●	●	●	●
CORSAIR	TR3X3G1600C9(XMP)Ver1.1	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1601-9-9-9-24)	1.65	●	●	●	●
CORSAIR	TR3X6G1600C8D(XMP)Ver2.1	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-24(1601-8-8-8-24)	1.65	●	●	●	●
CORSAIR	TR3X6G1600C9(XMP)Ver2.1	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.65	●	●	●	●
KINGSTON	KHX12800D3LK3/3GX(XMP)	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	●	●	●	●
OCZ	OCZ3G1600LV3GK	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-20)	1.65	●	●	●	●
OCZ	OCZ3G1600LV6GK	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-20)	1.65	●	●	●	●

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409**

**P6T WS PRO DDR3 1800 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
KINGSTON	KHX14400D3K3/GX(XMP)	DDR3 1800	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409**

**P6T WS PRO DDR3 1866 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
KINGSTON	KHX14900D3K3/GX(XMP)	DDR3 1866	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•
Aeneon	AXH860UD20-18J(XMP)	DDR3 1866	2048MB	DS	N/A	Heat-Sink Package	10(1333-8-8-8-24)		•	• •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409**

**P6T WS PRO DDR3 2000 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
KINGSTON	KHX16000D3K3/GX(XMP)	DDR3 2000	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	• •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0702**

**P6T WS PRO DDR3 1800 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
Apacer	78.0AGCD-CDZ(XMP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1800-8-8-8-24)	1.8	•	• •
Apacer	BoxP/N:DH.02GAL F7LK2 (78.0AGCB.BN0)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	7-7-7-20		•	
CORSAIR	CM3X1024-1800C7DIN(XMP)	DDR3 1800	1024MB	SS	N/A	Heat-Sink Package	7		•	• •
CORSAIR	BoxP/N:TW3X4G1800C8DF (CM3X2G1800C8D)Ver4.1	DDR3 1800	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-24	1.80	•	
KINGSTON	KHX14400D3/1G	DDR3 1800	1024MB	SS	N/A	Heat-Sink Package		1.9	•	• •
KINGSTON	KHX14400D3K2/2G	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	• •
KINGSTON	KHX14400D3K2/2GN(EPP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	• •
KINGSTON	KHX14400D3K3/GX(XMP)	DDR3 1800	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	1800-9-9-9-27	1.65	•	• •
OCZ	OCZ3P18002GK	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	• • •
Transcend	TX1800KLU-2GK(XMP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	• •
Patriot	PVS32G1800LLKN(EPP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-20(1066-7-7-7-20)	1.9	•	• • •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0702**

**P6T WS PRO DDR3 1866 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
CORSAIR	TR3X3G1866C9D(XMP)	DDR3 1866	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1866-9-9-9-24)	1.65	•	• • •
CORSAIR	TR3X6G1866C9D	DDR3 1866	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1866-9-9-9-24)	1.65	•	• • •
KINGSTON	KHX14900D3K3/GX(XMP)	DDR3 1866	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	• • •
OCZ	OCZ3P1866C9LV6GK	DDR3 1866	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	•	• • • •
OCZ	OCZ3RPR1866C9LV6GK	DDR3 1866	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	•	• • • •
Super Talent	W1866UX2GB(XMP)	DDR3 1866	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)		•	• • • •
Patriot	PVS32G1866LLK(XMP)	DDR3 1866	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1066-7-7-7-20)	1.9	•	• • • •
Patriot	PVS32G1866LLK(XMP)	DDR3 1866	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1866-8-8-8-24)	1.9	•	• • • •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0702**

**P6T WS PRO DDR3 2000 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
CORSAIR	BoxP/N:TW3X2G2000DFNV (CM3X1G2000DFNV)(EPP)Ver3.1	DDR3 2000	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-24	1.9	•	• • •
Crucial	BL12864BE2009.8SFB3(EPP)	DDR3 2000	1024MB	SS	N/A	Heat-Sink Package	9-9-9-28(1333-9-9-9-24)	2	•	• • •
G.SKILL	F3-1600CL9T-3GBDI-B(XMP)	DDR3 2000	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(2000-9-9-9-24)	1.65	•	• • •
KINGSTON	KHX16000D3K2/2GN(EPP)	DDR3 2000	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		2.0	•	• • •
KINGSTON	KHX16000D3K3/GX(XMP)	DDR3 2000	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	• • •
OCZ	OCZ3FXT20002GK	DDR3 2000	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8	1.9	•	• • •
Gingle	9CAASS37AZZ01D1	DDR3 2000	2048MB	DS	N/A	Heat-Sink Package	9-9-9-24		•	• • •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0603**

**P6T WS PRO DDR3 1333 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
Apacer	78.01GC8.422	DDR3 1333	1024MB	SS	ELPIDA	J1108BABG-DJ-E(ECC)	(1333-9-9-9-24)		•	• • • •
Apacer	78.A1GC8.423	DDR3 1333	2048MB	DS	ELPIDA	J1108BABG-DJ-E(ECC)	(1333-9-9-9-24)		•	• • • •
SAMSUNG	M391B2873DZ1-CH9	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		•	• • • •
SAMSUNG	M391B5673DZ1-CH9	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		•	• • • •
SAMSUNG	M378B5273BH1-CH9	DDR3 1333	4096MB	DS	SAMSUNG	K4B2G0846B-HCH9	9(1333-9-9-9-24)		•	• • • •

**P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0603**

**P6T WS PRO DDR3 1067 Qualified Vendors List (QVL)**

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	IMM	socket support (Options)
									A*	B* C* D*
ELPIDA	EBJ11RD8BAFA-AE-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E(ECC)	7		•	• • • •
SAMSUNG	M378B5273BH1-CF8	DDR3 1067	4096MB	DS	SAMSUNG	K4B2G0846B-HCF8	8(7-7-7-20)	1.5	•	• • • •
ASUS	04G00161796T	DDR3 1067	1024MB	SS	ELPIDA	J1108BABG-DJ-E 084809JPY			•	• • • •
ASUS	04G00161894D	DDR3 1067	2048MB	DS	ELPIDA	J1108BABG-DJ-E 084809JPY			•	• • • •

6 Dimm :

- A\*: Supports two (2) modules inserted into slot A1 and B1 as one pair of Dual-channel memory configuration
- B\*: Supports three (3) modules inserted into the orange slots (A1, B1 and C1) as one set of Triple-channel memory configuration
- C\*: Supports four (4) modules inserted into the orange slots (A1, B1 and C1) and the black slot A2 as one set of Triple-channel memory configuration
- D\*: Supports six (6) modules inserted into both the orange slots and the black slots as two set of Triple-channel memory configuration.

-When installing total memory of 4GB capacity or more, Windows 32-bit operation system may only recognize less than 3GB. Hence, a total installed memory of less than 3GB is recommended.

-It is recommended to install the memory modules from the slots for better overlocking capability.

-The default DIMM frequency depends on its Serial Presence Detect (SPD), which is the standard way of accessing information from a memory module. Under the default state, some memory modules for overlocking may operate at a lower frequency than the vendor-marked value.